TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type (U-MOSIV)

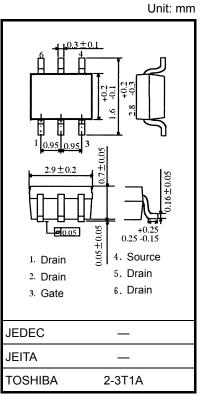
TPC6108

Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package
- Low drain-source ON-resistance: $RDS(ON) = 50 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance: $|Y_{fs}| = 7.4 \text{ S (typ.)}$
- Low leakage current: $IDSS = -10 \mu A (max) (VDS = -30 V)$
- Enhancement mode: $V_{th} = -0.8 \text{ to } -2.0 \text{ V (V}_{DS} = -10 \text{ V, I}_{D} = -1 \text{ mA)}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	ymbol Rating		
Drain-source volta	Drain-source voltage			-30	V	
Drain-gate voltage	Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)			-30	V	
Gate-source voltage			V_{GSS}	±20	V	
Drain aurrent	DC	(Note 1)	I _D	-4.5	А	
Drain current	Pulse	(Note 1)	I _{DP}	-18		
Drain power dissip	Drain power dissipation (t = 5 s) (Note 2a)			2.2	W	
Drain power dissipation (t = 5 s) (Note 2b)			PD	0.7		
Single-pulse avalanche energy (Note 3)			E _{AS}	1.3	mJ	
Avalanche current			I _{AR}	-2.25	Α	
Repetitive avalanche energy Single-device value at dual operation (Note 4)			E _{AR}	0.22	mJ	
Channel temperature			T _{ch}	150	°C	
Storage temperature range			T _{stg}	-55 to 150	°C	



Weight: 0.011 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

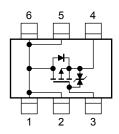
Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	R _{th (ch-a)}	56.8	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R _{th (ch-a)}	178.5	°C/W

Note: For Notes 1 to 5, see page 3.

Caution: This transistor is an electrostatic-sensitive device. Handle with care.

Circuit Configuration



Electrical Characteristics (Ta = 25°C)

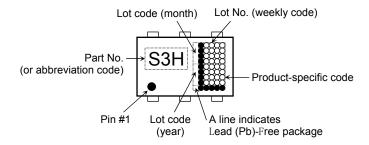
Ch	aracteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Drain cut-off curr	ent	I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	_	<u> </u>		μА
Drain-source breakdown voltage		V _{(BR) DSS}	$I_D = -10$ mA, $V_{GS} = 0$ V	-30	_		V
		V _{(BR)DSX}	$I_D = -10$ mA, $V_{GS} = 20$ V	-15	_	_	
Gate threshold voltage		V _{th}	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	-0.8	_	-2.0	V
Drain-source ON-resistance		R _{DS} (ON)	$V_{GS} = -4.5 \text{ V}, I_D = -2.2 \text{ A}$	_	75	100	mΩ
		R _{DS} (ON)	$V_{GS} = -10 \text{ V}, I_D = -2.2 \text{ A}$	_	50	60	
Forward transfer admittance		Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -2.2 \text{ A}$	3.7	7.4	_	S
Input capacitance	е	C _{iss}		_	570	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	75	_	pF
Output capacitance		Coss		_	85	_	
Switching time	Rise time	t _r	V _{GS} 0 V I _D = -2.2 A V _{OUT} C S S S S S S S S S		3.5		- ns
	Turn-on time	t _{on}		_	12	_	
	Fall time	t _f		_	21	_	
	Turn-off time	t _{off}	V _{DD} ≈ −15 V Duty ≤ 1%, t _W = 10 μs	_	70	_	
Total gate charge (gate-source plus gate-drain)		Qg	V _{DD} ≈ -24 V, V _{GS} ≈ -10 V,	_	13		
Gate-source charge1		Q _{gs1}	$I_D = -4.5 \text{ A}$	_	1.8	_	nC
Gate-drain ("Miller") charge		Q _{gd}		_	2.5		

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	_	_	_	-18	Α
Forward voltage (diode)		V_{DSF}	$I_{DR} = -4.5 \text{ A}, V_{GS} = 0 \text{ V}$	_		1.2	V



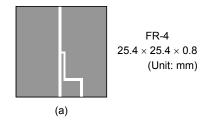
Marking (Note 5)

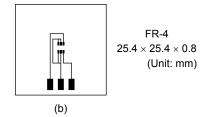


Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a) (t = 5 s)

(b) Device mounted on a glass-epoxy board (b) (t = 5 s)



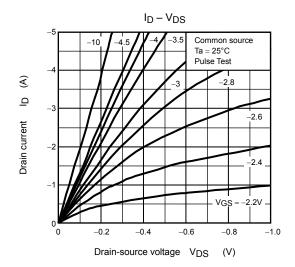


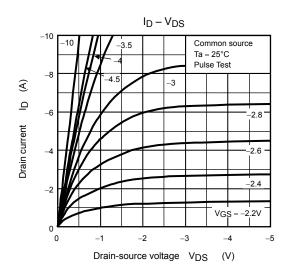
Note 3: $V_{DD} = -24~V,~T_{ch} = 25^{\circ}C$ (initial), L = 0.2 mH, R_G = 25 $\Omega,$ I_{AR} = -2.25 A

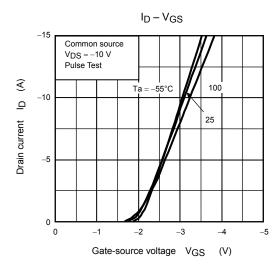
Note 4: Repetitive rating: pulse width limited by max channel temperature

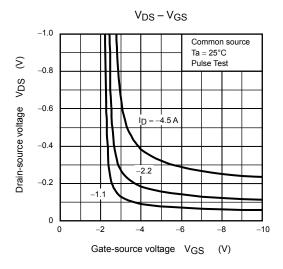
Note 5: ● to the lower left of the Part No. marking indicates Pin 1.

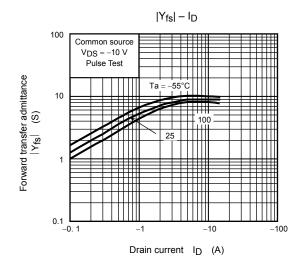
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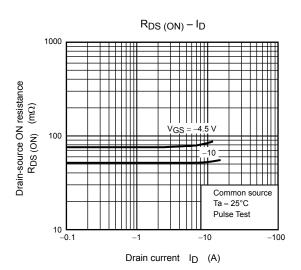


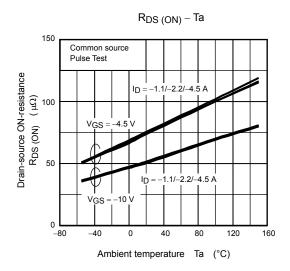


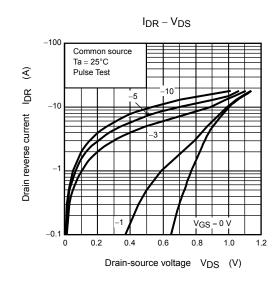


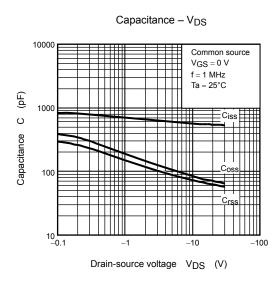


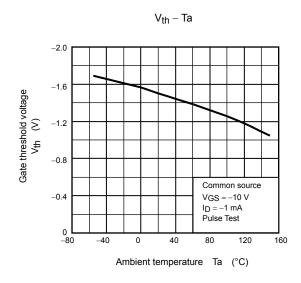


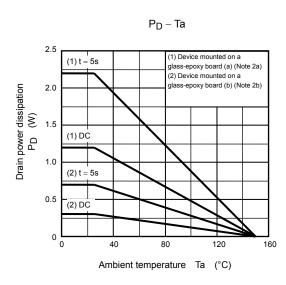


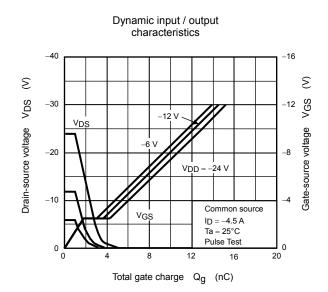


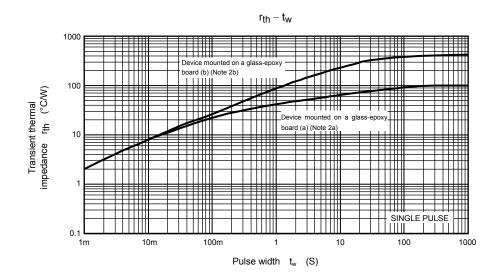




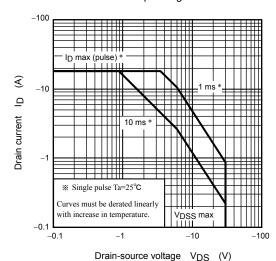








Safe Operating Area



RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

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